



US00D407690S

United States Patent [19]

Lai et al.

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[54] **HIGH DENSITY ELECTRICAL CONNECTOR**

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[73] Assignee: **Hon Hai Precision Ind. Co., Ltd.**,
Taipei Hsien, Taiwan

[**] Term: **14 Years**

[21] Appl. No.: **79,654**

[22] Filed: **Nov. 21, 1997**

[30] **Foreign Application Priority Data**

May 30, 1997 [TW] Taiwan 86304705

[51] **LOC (6) Cl.** **13-03**

[52] **U.S. Cl.** **D13/147**

[58] **Field of Search** D13/146, 147;
439/79-83, 95, 101, 108, 181, 607-610,
620

[56] **References Cited**

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Primary Examiner—Alan P. Douglas
Assistant Examiner—Lavone D. Tabor

[57] **CLAIM**

The ornamental design for a high density electrical connector, as shown.

DESCRIPTION

FIG. 1 is a perspective view of a high density electrical connector showing my new design;

FIG. 2 is a front elevational view thereof;

FIG. 3 is a rear elevational view thereof;

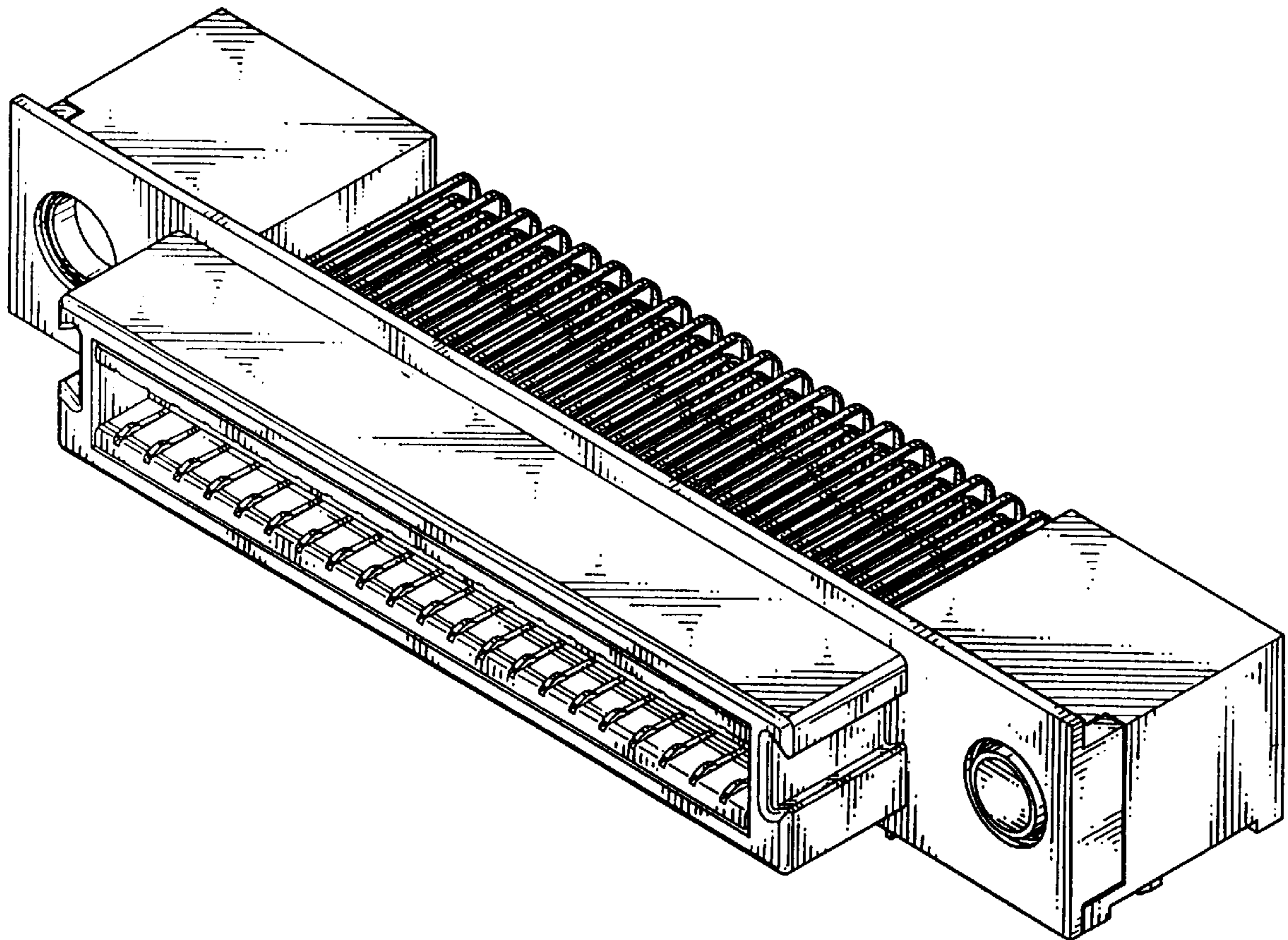
FIG. 4 is a left side elevational view thereof;

FIG. 5 is a right side elevational view thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

1 Claim, 7 Drawing Sheets



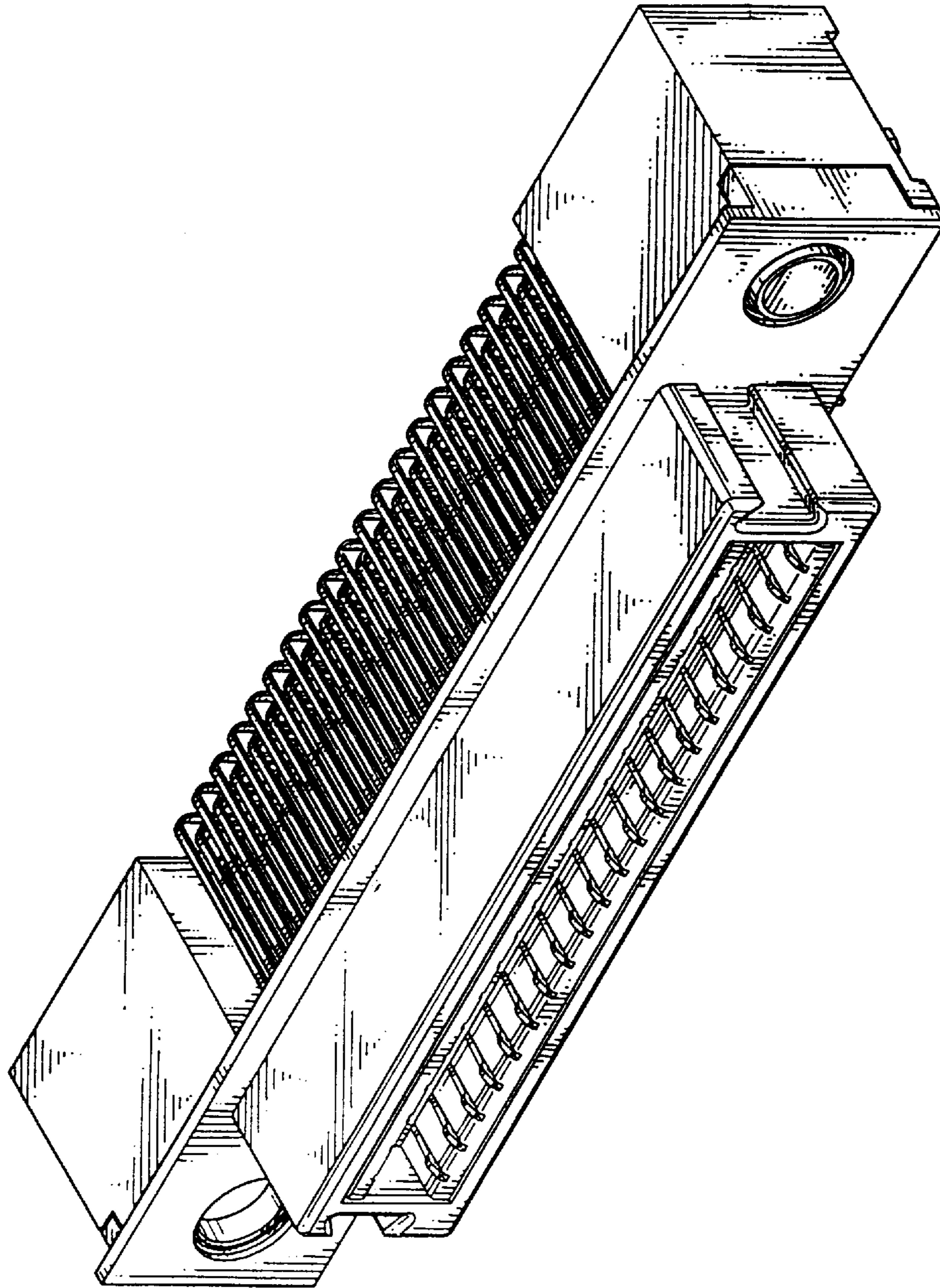


FIG.1

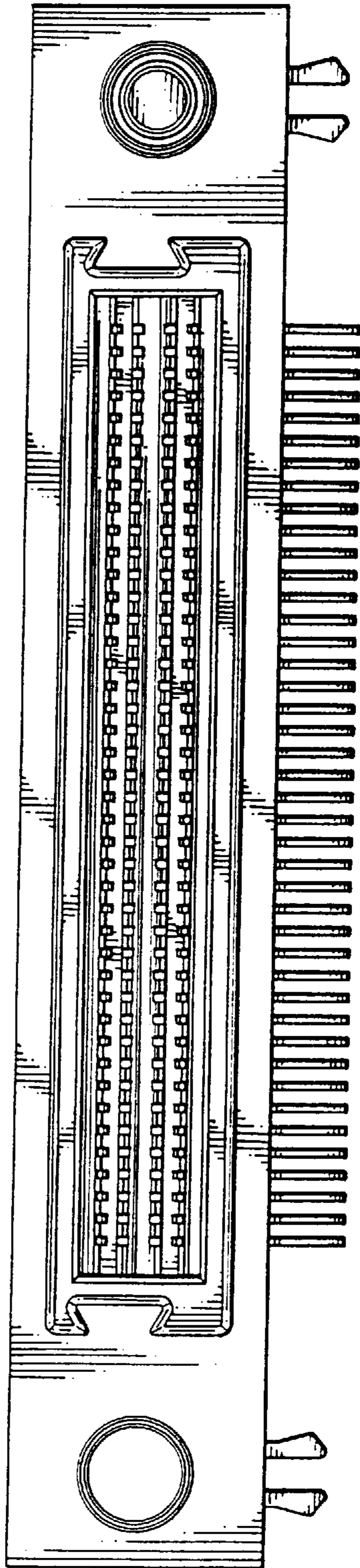


FIG.2

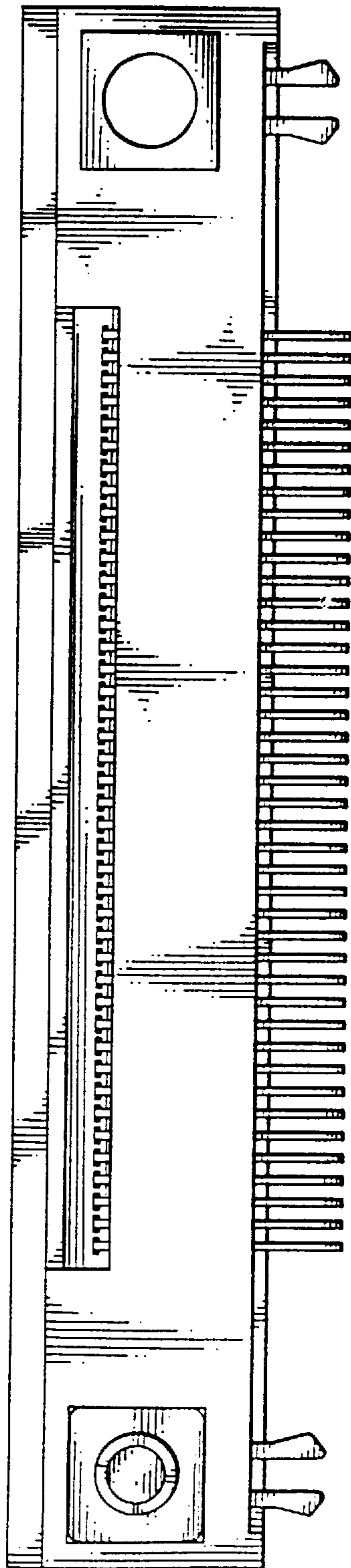


FIG.3

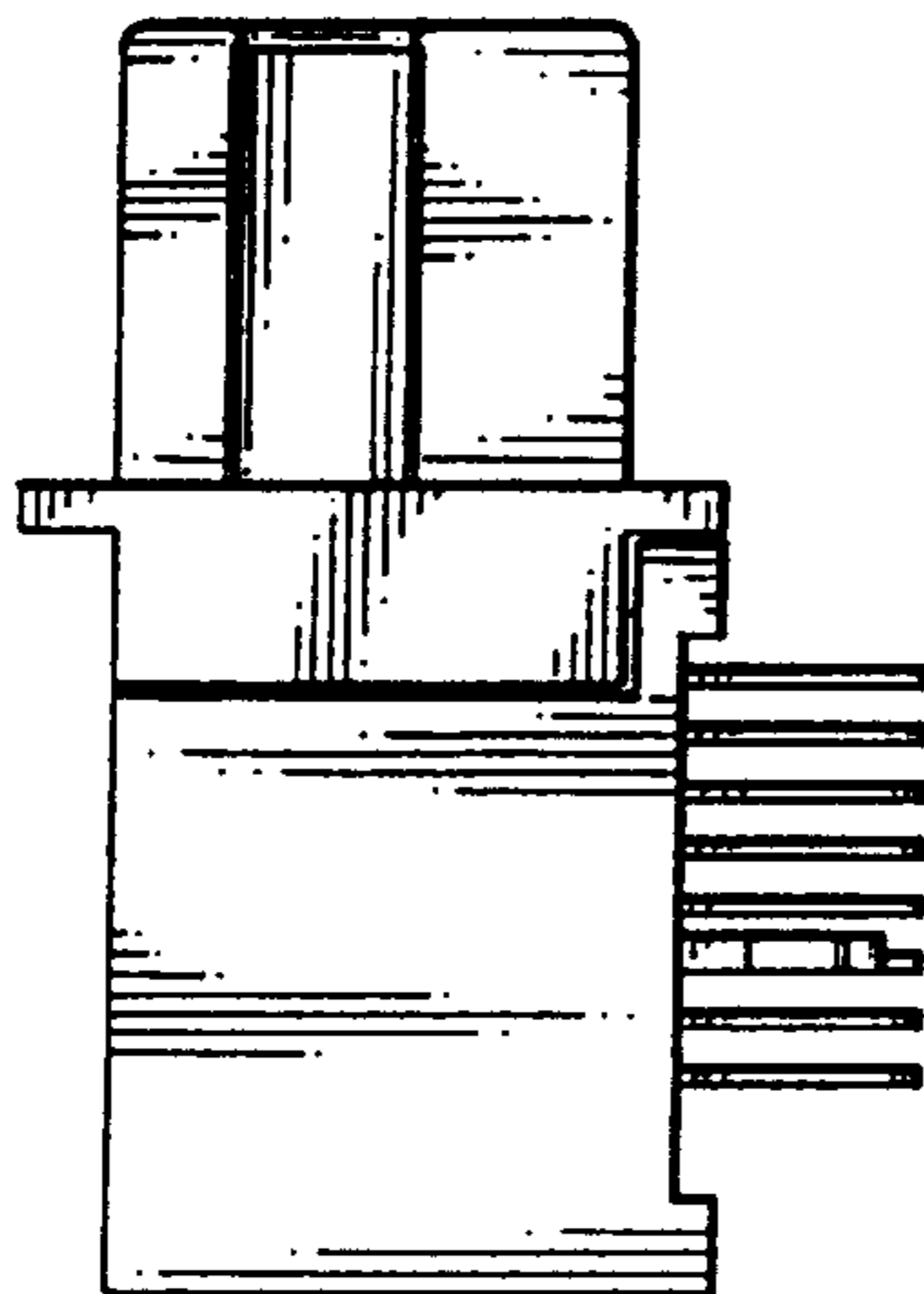


FIG.4

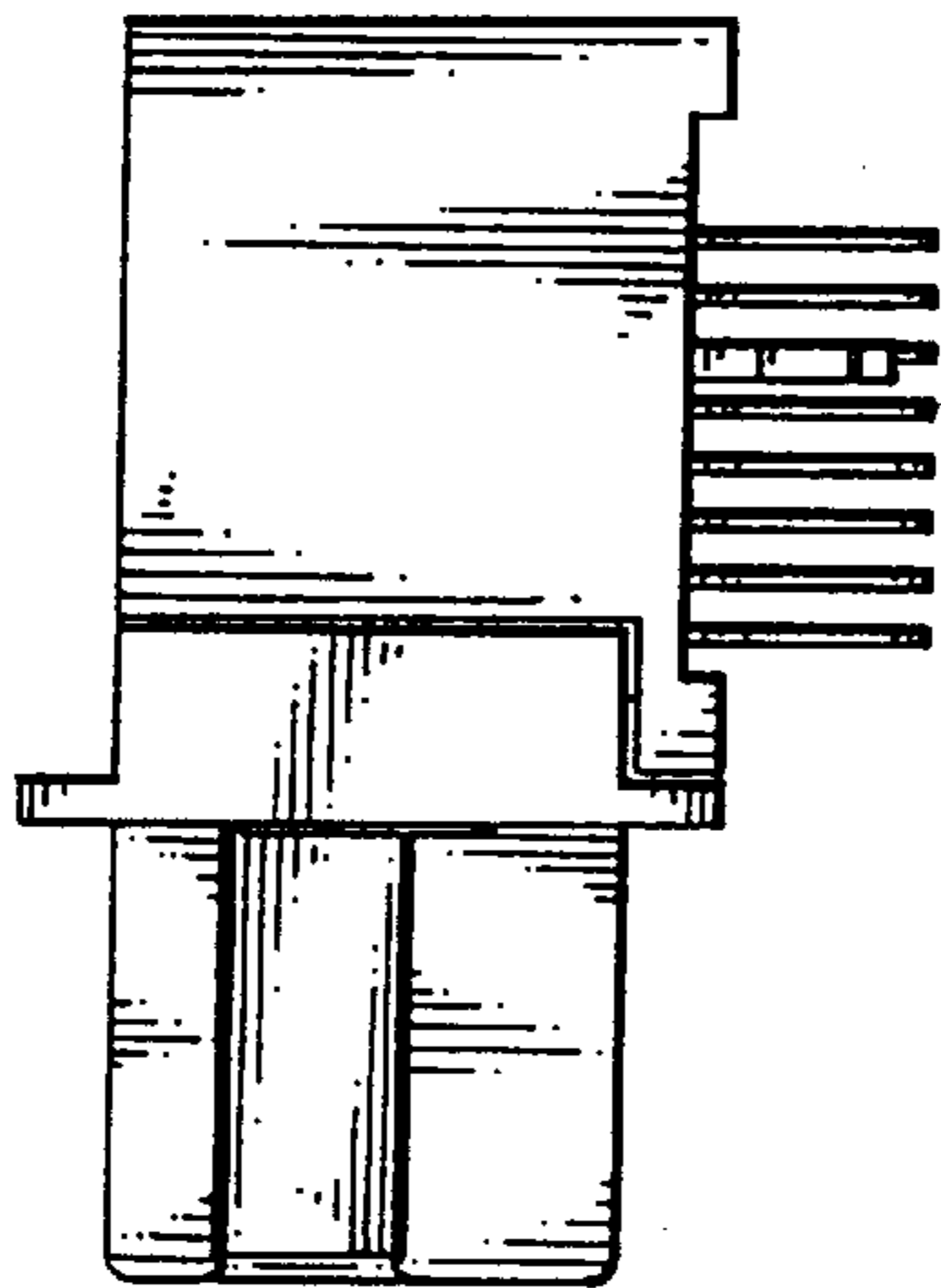


FIG. 5

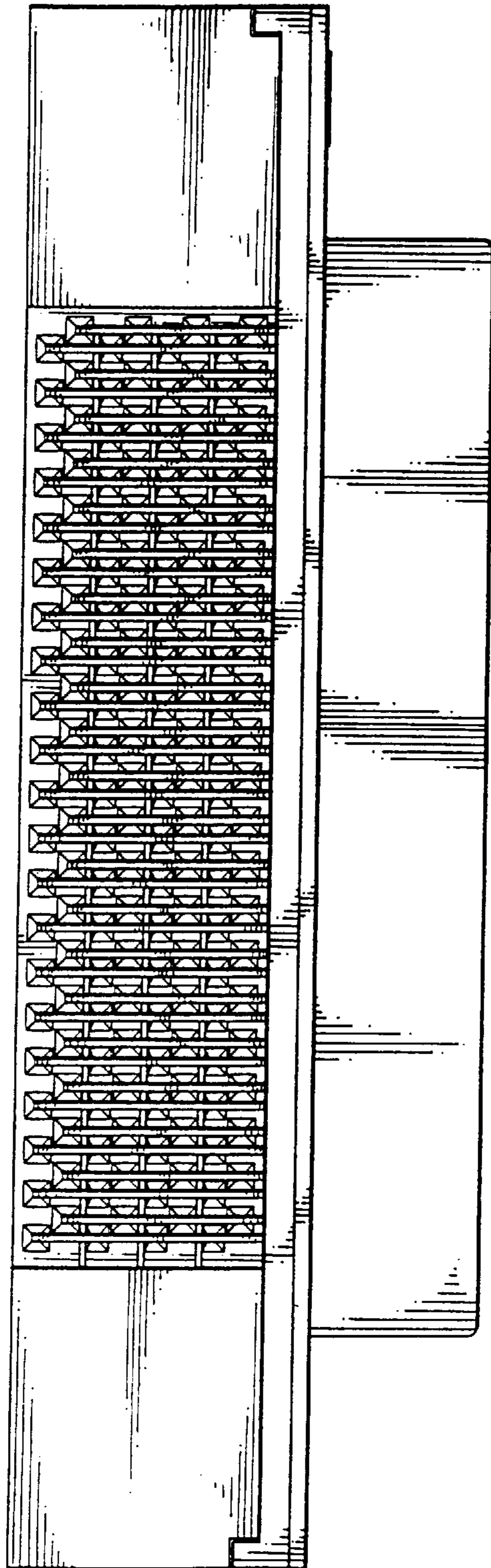


FIG.6

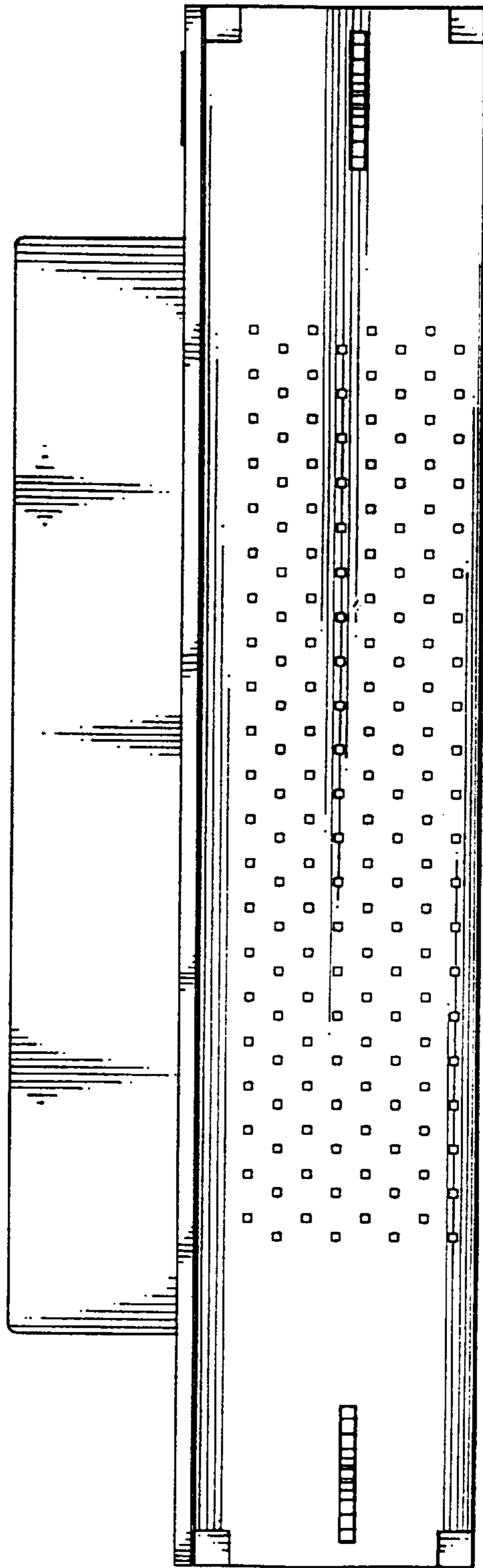


FIG. 7